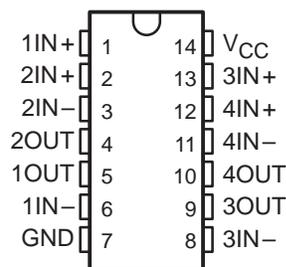


# LM2900, LM3900 QUADRUPLE NORTON OPERATIONAL AMPLIFIERS

SLOS059 – JULY 1979 – REVISED SEPTEMBER 1990

- Wide Range of Supply Voltages, Single or Dual Supplies
- Wide Bandwidth
- Large Output Voltage Swing
- Output Short-Circuit Protection
- Internal Frequency Compensation
- Low Input Bias Current
- Designed to Be Interchangeable With National Semiconductor LM2900 and LM3900, Respectively

N PACKAGE  
(TOP VIEW)

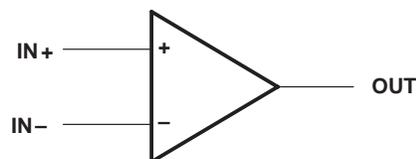


## description

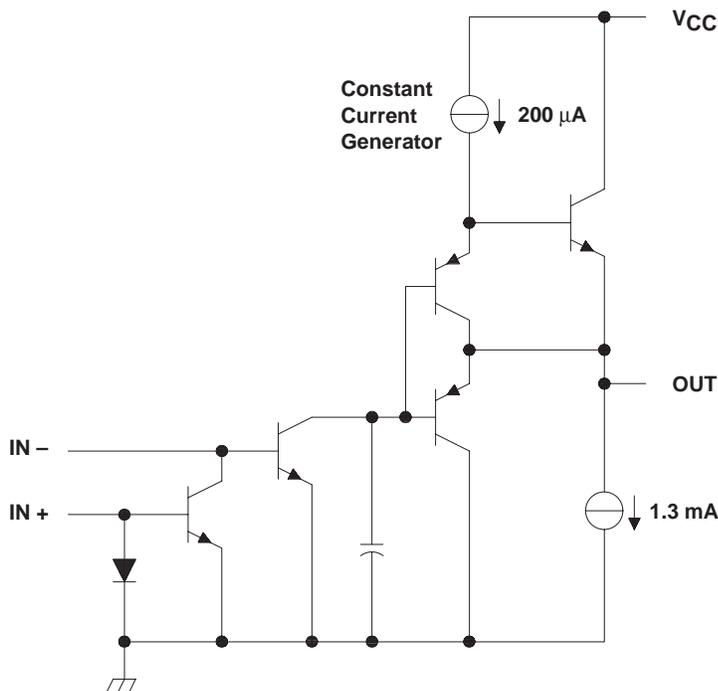
These devices consist of four independent, high-gain frequency-compensated Norton operational amplifiers that were designed specifically to operate from a single supply over a wide range of voltages. Operation from split supplies is also possible. The low supply current drain is essentially independent of the magnitude of the supply voltage. These devices provide wide bandwidth and large output voltage swing.

The LM2900 is characterized for operation from  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ , and the LM3900 is characterized for operation from  $0^{\circ}\text{C}$  to  $70^{\circ}\text{C}$ .

## symbol (each amplifier)



## schematic (each amplifier)



PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS  
INSTRUMENTS**

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# LM2900, LM3900 QUADRUPLE NORTON OPERATIONAL AMPLIFIERS

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## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

	LM2900	LM3900	UNIT
Supply voltage, $V_{CC}$ (see Note 1)	36	36	V
Input current	20	20	mA
Duration of output short circuit (one amplifier) to ground at (or below) 25°C free-air temperature (see Note 2)	unlimited	unlimited	
Continuous total dissipation	See Dissipation Rating Table		
Operating free-air temperature range	-40 to 85	0 to 70	°C
Storage temperature range	-65 to 150	-65 to 150	°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260	260	°C

- NOTES: 1. All voltage values, except differential voltages, are with respect to the network ground terminal.  
2. Short circuits from outputs to  $V_{CC}$  can cause excessive heating and eventual destruction.

DISSIPATION RATING TABLE

PACKAGE	$T_A \leq 25^\circ\text{C}$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25^\circ\text{C}$	$T_A = 70^\circ\text{C}$ POWER RATING	$T_A = 85^\circ\text{C}$ POWER RATING
N	1150 mW	9.2 mW/°C	736 mW	598 mW

## recommended operating conditions

	LM2900		LM3900		UNIT
	MIN	MAX	MIN	MAX	
Supply voltage, $V_{CC}$ (single supply)	4.5	32	4.5	32	V
Supply voltage, $V_{CC+}$ (dual supply)	2.2	16	2.2	16	V
Supply voltage, $V_{CC-}$ (dual supply)	-2.2	-16	-2.2	-16	V
Input current (see Note 3)		-1		-1	mA
Operating free-air temperature, $T_A$	-40	85	0	70	°C

NOTE 3: Clamp transistors are included that prevent the input voltages from swinging below ground more than approximately -0.3 V. The negative input currents that may result from large signal overdrive with capacitive input coupling must be limited externally to values of approximately -1 mA. Negative input currents in excess of -4 mA causes the output voltage to drop to a low voltage. These values apply for any one of the input terminals. If more than one of the input terminals are simultaneously driven negative, maximum currents are reduced. Common-mode current biasing can be used to prevent negative input voltages.



# LM2900, LM3900

## QUADRUPLE NORTON OPERATIONAL AMPLIFIERS

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### electrical characteristics, $V_{CC} = 15\text{ V}$ , $T_A = 25^\circ\text{C}$ (unless otherwise noted)

PARAMETER	TEST CONDITION†	LM2900			LM3900			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	
$I_{IB}$ Input bias current (inverting input)	$I_{I+} = 0$	$T_A = 25^\circ\text{C}$		30	200	30	200	nA
		$T_A = \text{Full range}$		300		300		
Mirror gain	$I_{I+} = 20\ \mu\text{A}$ to $200\ \mu\text{A}$ $T_A = \text{Full range}$ , See Note 4	0.9	1.1	0.9	1.1	$\mu\text{A}/\mu\text{A}$		
Change in mirror gain		2%	5%	2%	5%			
Mirror current	$V_{I+} = V_{I-}$ , See Note 4	$T_A = \text{Full range}$ ,	10	500	10	500	$\mu\text{A}$	
$A_{VD}$ Large-signal differential voltage amplification	$V_O = 10\text{ V}$ , $f = 100\text{ Hz}$	$R_L = 10\text{ k}\Omega$ ,	1.2	2.8	1.2	2.8	V/mV	
$r_i$ Input resistance (inverting input)			1		1	M $\Omega$		
$r_o$ Output resistance			8		8	k $\Omega$		
$B_1$ Unity-gain bandwidth (inverting input)			2.5		2.5	MHz		
$k_{SVR}$ Supply voltage rejection ratio ( $\Delta V_{CC}/\Delta V_{IO}$ )			70		70	dB		
$V_{OH}$ High-level output voltage	$I_{I+} = 0$ , $I_{I-} = 0$	$R_L = 2\text{ k}\Omega$	13.5		13.5		V	
		$V_{CC} = 30\text{ V}$ , No load	29.5		29.5			
$V_{OL}$ Low-level output voltage	$I_{I+} = 0$ , $R_L = 2\text{ k}\Omega$	$I_{I-} = 10\ \mu\text{A}$ ,	0.09	0.2	0.09	0.2	V	
$I_{OS}$ Short-circuit output current (output internally high)	$I_{I+} = 0$ , $V_O = 0$	$I_{I-} = 0$ ,	-6	-18	-6	-10	mA	
			0.5	1.3	0.5	1.3	mA	
$I_{OL}$ Low-level output current‡	$I_{I-} = 5\ \mu\text{A}$	$V_{OL} = 1\text{ V}$	5		5		mA	
$I_{CC}$ Supply current (four amplifiers)	No load		6.2	10	6.2	10	mA	

† All characteristics are measured under open-loop conditions with zero common-mode voltage unless otherwise specified. Full range for  $T_A$  is  $-40^\circ\text{C}$  to  $85^\circ\text{C}$  for LM2900 and  $0^\circ\text{C}$  to  $70^\circ\text{C}$  for LM3900.

‡ The output current-sink capability can be increased for large-signal conditions by overdriving the inverting input.

NOTE 4: These parameters are measured with the output balanced midway between  $V_{CC}$  and GND.

### operating characteristics, $V_{CC\pm} = \pm 15\text{ V}$ , $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
SR Slew rate at unity gain	$V_O = 10\text{ V}$ , $C_L = 100\text{ pF}$ , $R_L = 2\text{ k}\Omega$	Low-to-high output			V/ $\mu\text{s}$
		High-to-low output			
			0.5		
			20		



# LM2900, LM3900 QUADRUPLE NORTON OPERATIONAL AMPLIFIERS

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## TYPICAL CHARACTERISTICS†

INPUT BIAS CURRENT (INVERTING INPUT)  
vs  
FREE-AIR TEMPERATURE

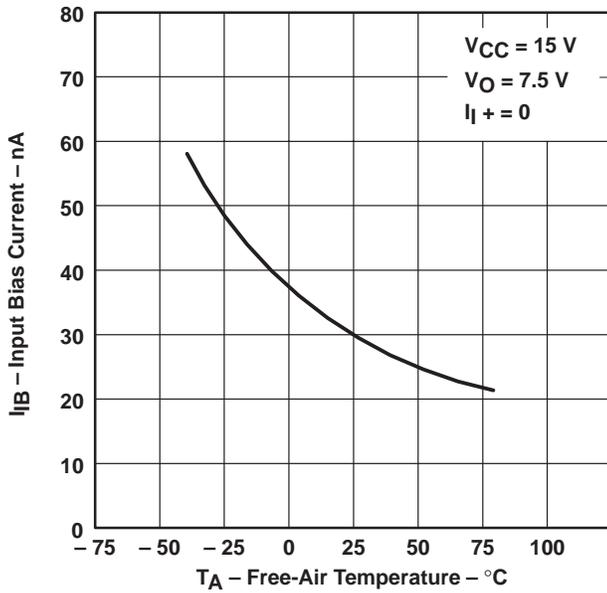


Figure 1

MIRROR GAIN  
vs  
FREE-AIR TEMPERATURE

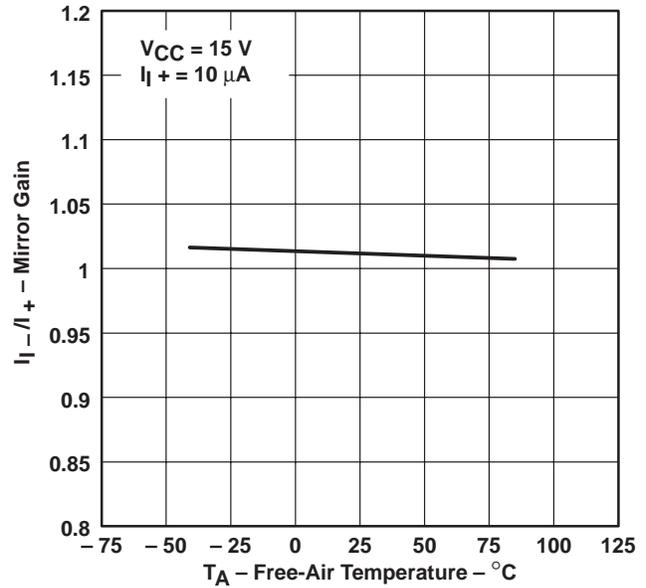


Figure 2

LARGE SIGNAL  
DIFFERENTIAL VOLTAGE AMPLIFICATION  
vs  
FREQUENCY

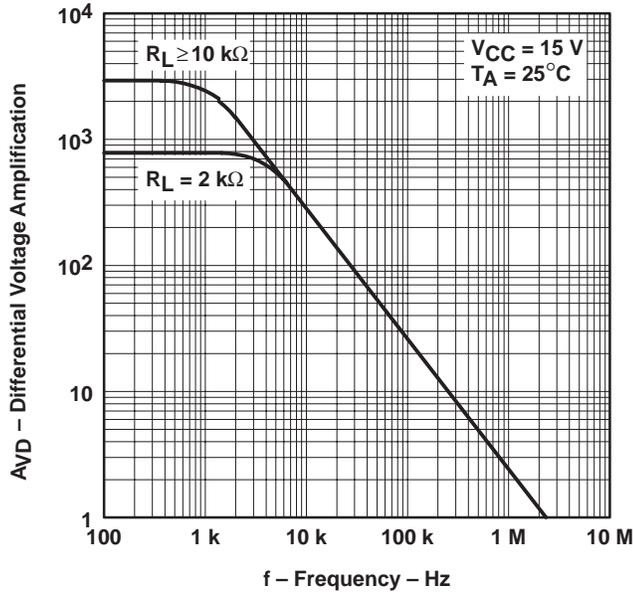


Figure 3

LARGE SIGNAL  
DIFFERENTIAL VOLTAGE AMPLIFICATION  
vs  
SUPPLY VOLTAGE

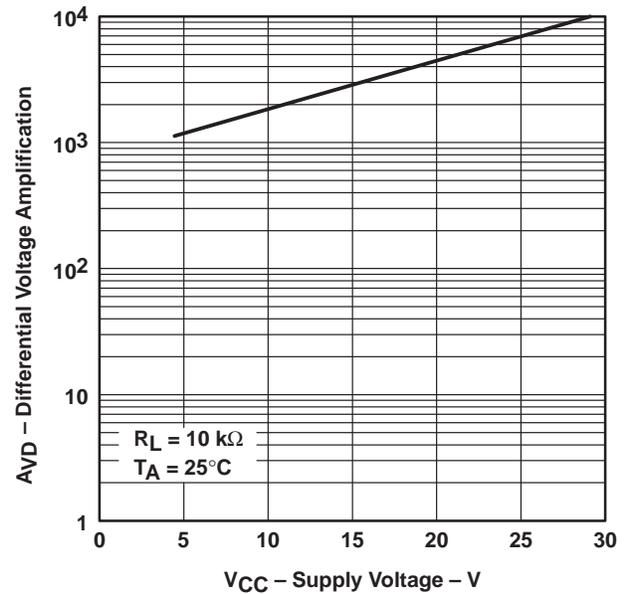
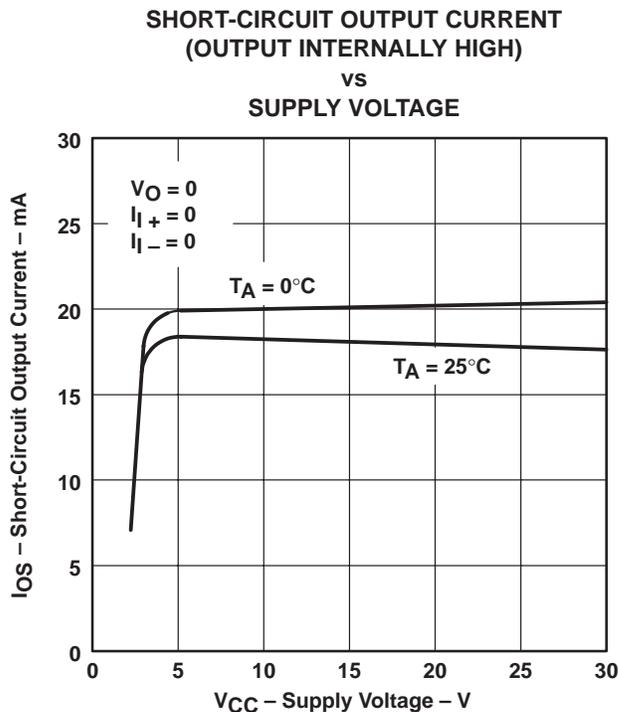
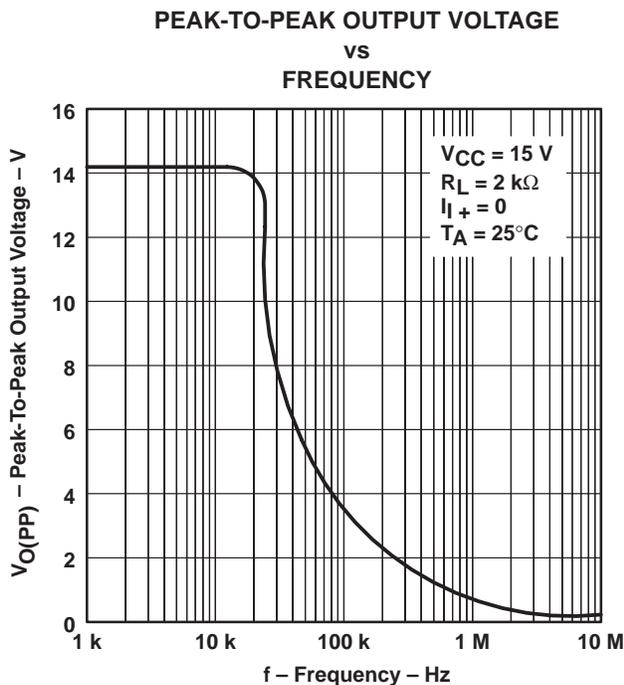
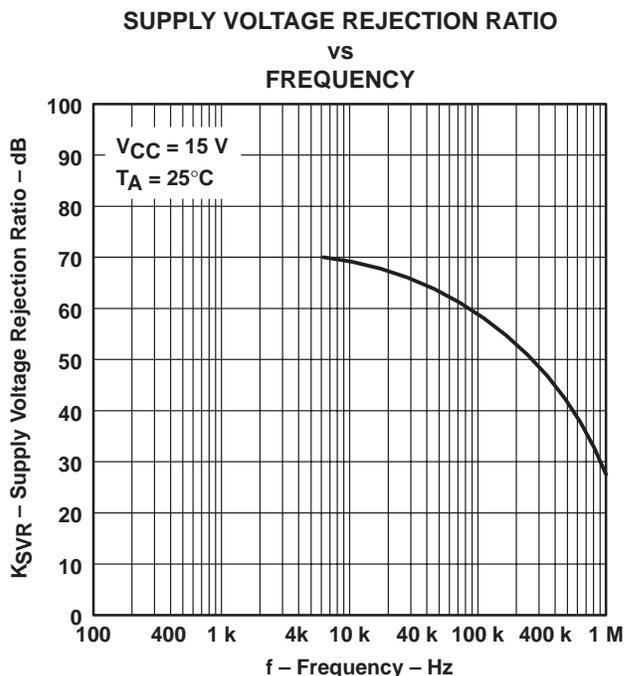
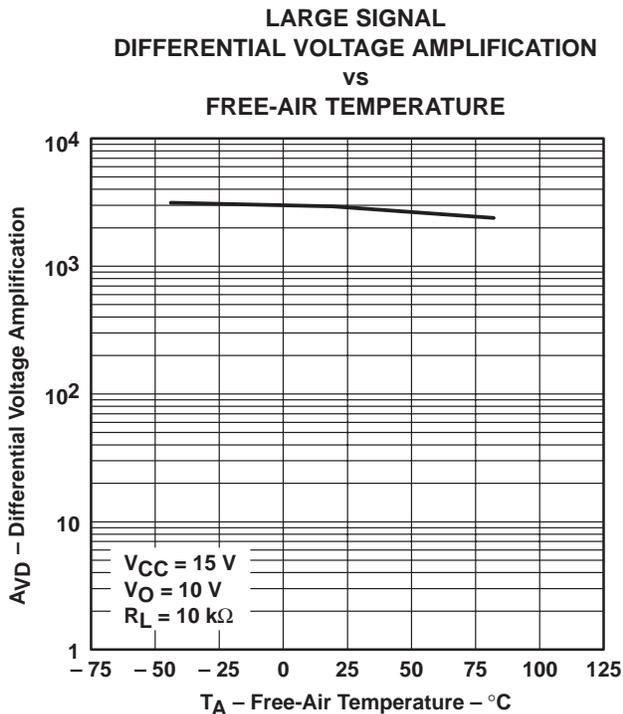


Figure 4

† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

TYPICAL CHARACTERISTICS†



† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

# LM2900, LM3900 QUADRUPLE NORTON OPERATIONAL AMPLIFIERS

SLOS059 – JULY 1979 – REVISED SEPTEMBER 1990

## TYPICAL CHARACTERISTICS†

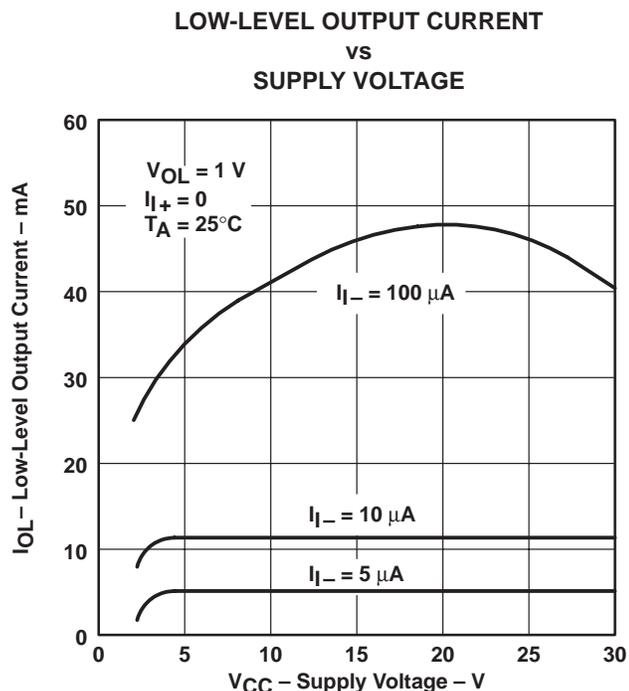


Figure 9

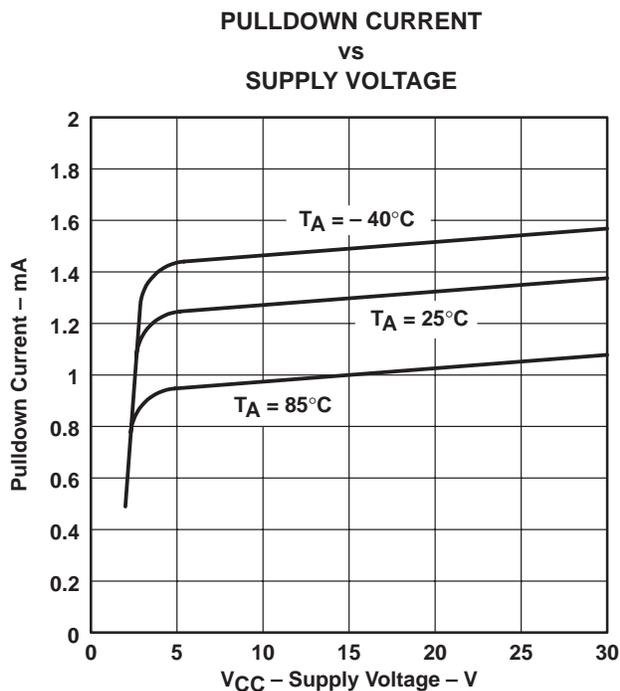


Figure 10

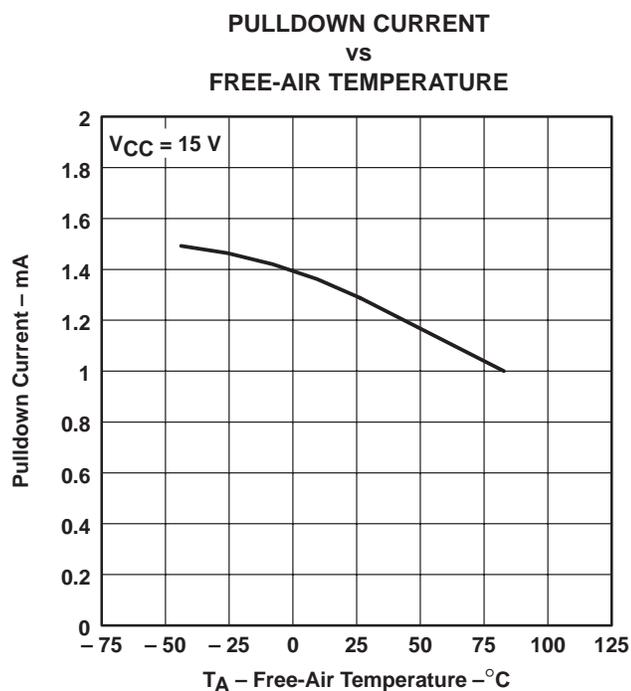


Figure 11

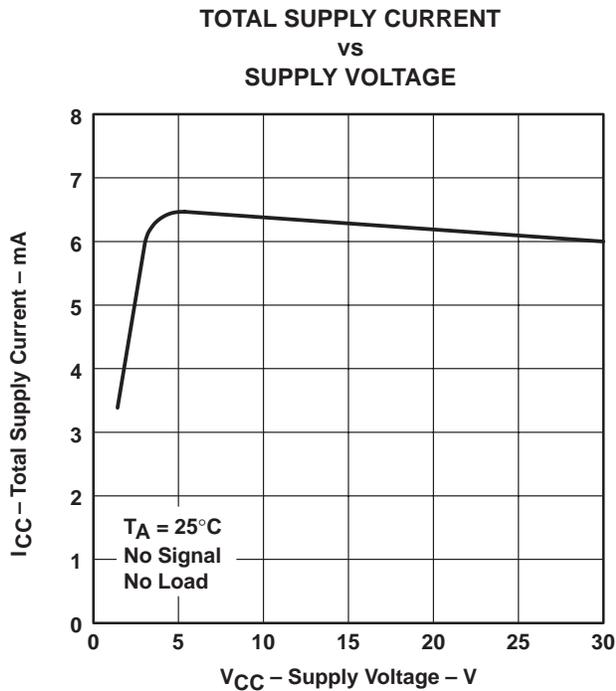


Figure 12

† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

APPLICATION INFORMATION

Norton (or current-differencing) amplifiers can be used in most standard general-purpose operational amplifier applications. Performance as a dc amplifier in a single-power-supply mode is not as precise as a standard integrated-circuit operational amplifier operating from dual supplies. Operation of the amplifier can best be understood by noting that input currents are differenced at the inverting input terminal and this current then flows through the external feedback resistor to produce the output voltage. Common-mode current biasing is generally useful to allow operating with signal levels near (or even below) ground.

Internal transistors clamp negative input voltages at approximately  $-0.3\text{ V}$  but the magnitude of current flow has to be limited by the external input network. For operation at high temperature, this limit should be approximately  $-100\ \mu\text{A}$ .

Noise immunity of a Norton amplifier is less than that of standard bipolar amplifiers. Circuit layout is more critical since coupling from the output to the noninverting input can cause oscillations. Care must also be exercised when driving either input from a low-impedance source. A limiting resistor should be placed in series with the input lead to limit the peak input current. Current up to  $20\ \text{mA}$  will not damage the device, but the current mirror on the noninverting input will saturate and cause a loss of mirror gain at higher current levels, especially at high operating temperatures.

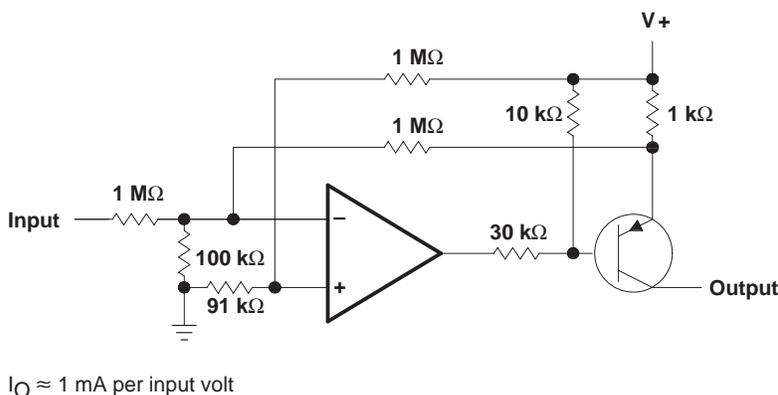


Figure 13. Voltage-Controlled Current Source

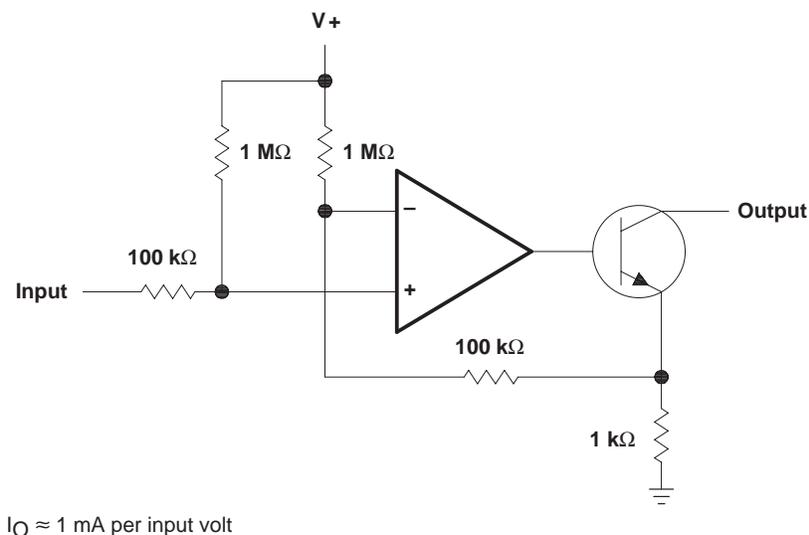


Figure 14. Voltage-Controlled Current Sink

**PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LM2900D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LM2900	<a href="#">Samples</a>
LM2900DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LM2900	<a href="#">Samples</a>
LM2900DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LM2900	<a href="#">Samples</a>
LM2900DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LM2900	<a href="#">Samples</a>
LM2900N	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	-40 to 85	LM2900N	<a href="#">Samples</a>
LM2900N	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	-40 to 85	LM2900N	<a href="#">Samples</a>
LM2900N	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	-40 to 85	LM2900N	<a href="#">Samples</a>
LM2900NE4	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	-40 to 85	LM2900N	<a href="#">Samples</a>
LM2900NE4	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	-40 to 85	LM2900N	<a href="#">Samples</a>
LM2900NE4	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	-40 to 85	LM2900N	<a href="#">Samples</a>
LM3900D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM3900	<a href="#">Samples</a>
LM3900D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM3900	<a href="#">Samples</a>
LM3900D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM3900	<a href="#">Samples</a>
LM3900DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM3900	<a href="#">Samples</a>
LM3900DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM3900	<a href="#">Samples</a>
LM3900DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM3900	<a href="#">Samples</a>
LM3900N	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	0 to 70	LM3900N	<a href="#">Samples</a>

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LM3900N	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	0 to 70	LM3900N	<a href="#">Samples</a>
LM3900N	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	0 to 70	LM3900N	<a href="#">Samples</a>
LM3900NE4	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	0 to 70	LM3900N	<a href="#">Samples</a>
LM3900NE4	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	0 to 70	LM3900N	<a href="#">Samples</a>
LM3900NE4	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	0 to 70	LM3900N	<a href="#">Samples</a>

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSELETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

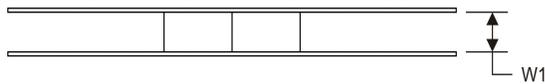
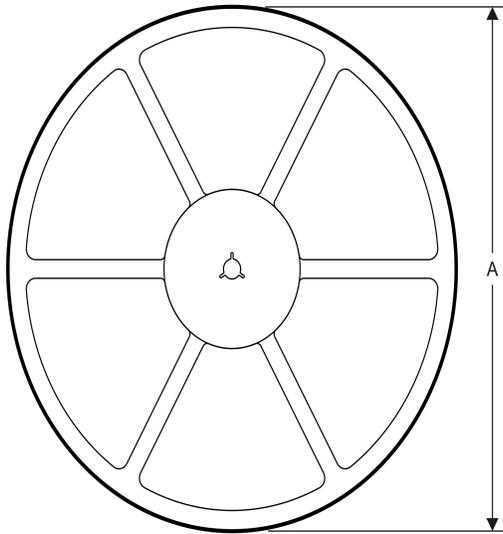
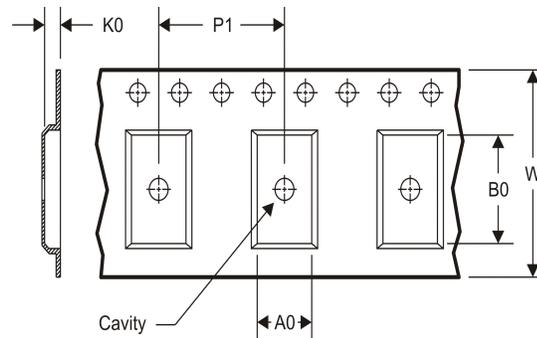
(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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**TAPE AND REEL INFORMATION**
**REEL DIMENSIONS**

**TAPE DIMENSIONS**


A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

**TAPE AND REEL INFORMATION**

\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM2900DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM3900DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1

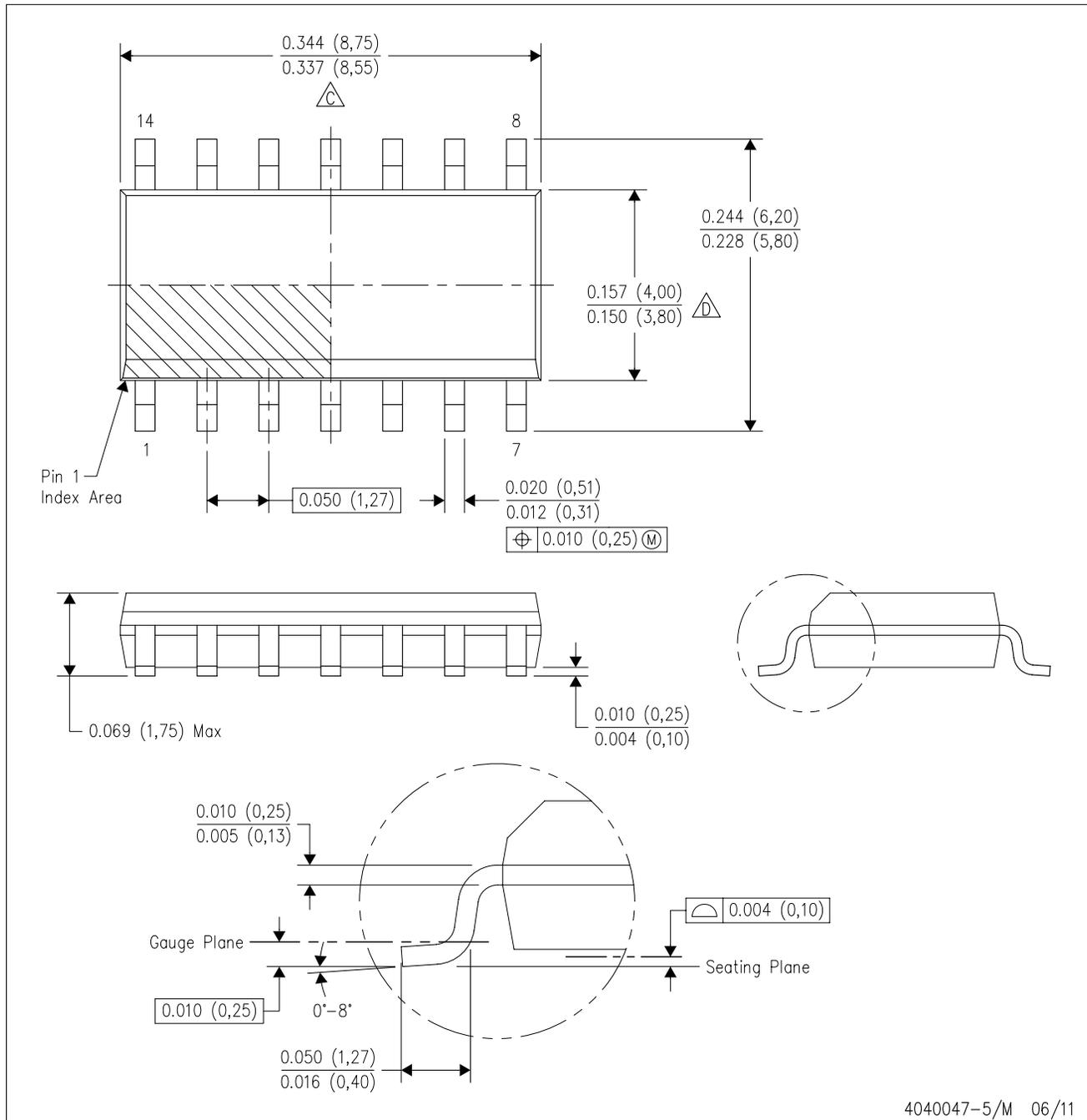
**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM2900DR	SOIC	D	14	2500	367.0	367.0	38.0
LM3900DR	SOIC	D	14	2500	367.0	367.0	38.0

D (R-PDSO-G14)

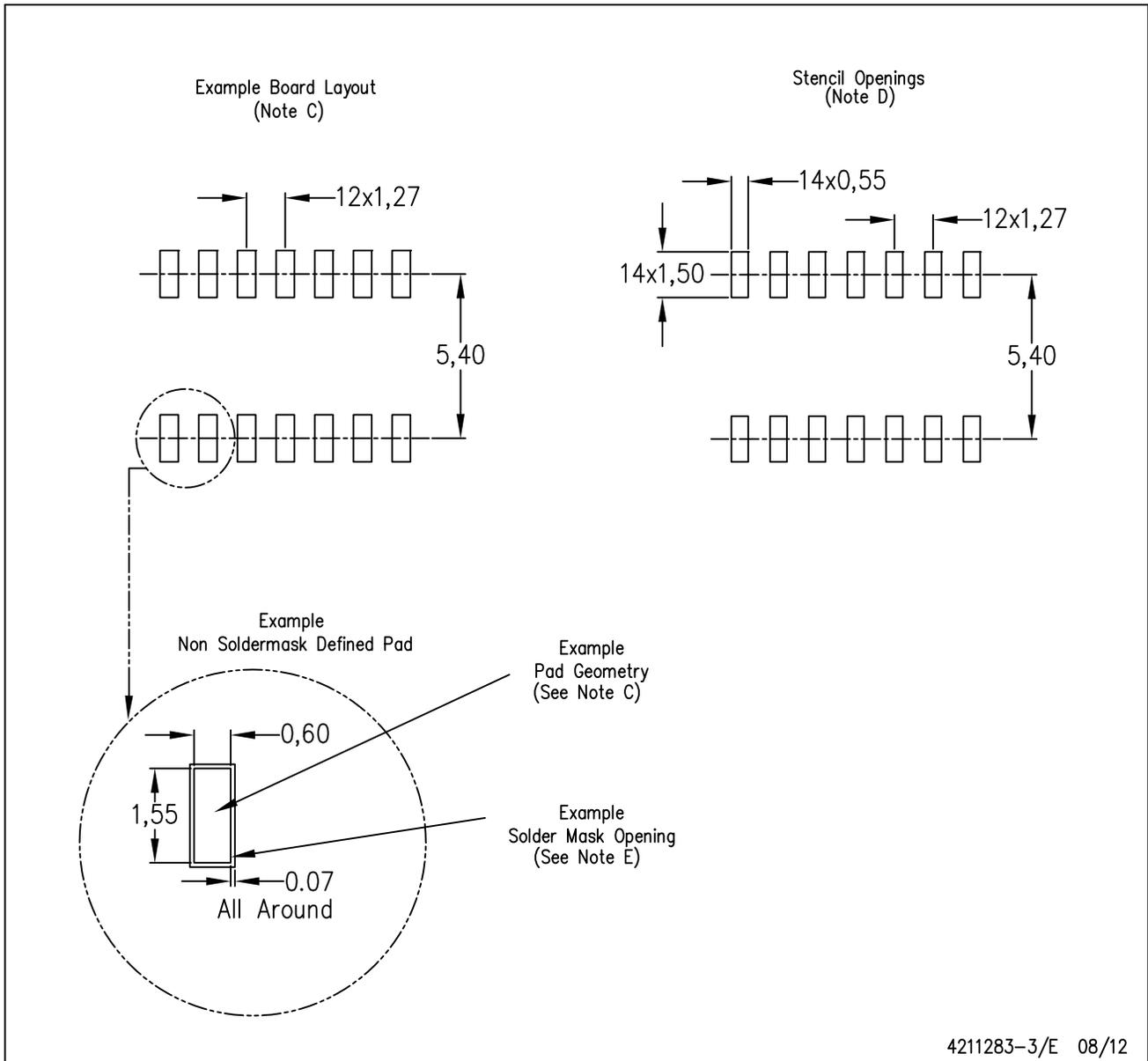
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  -  Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
  -  Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
  - E. Reference JEDEC MS-012 variation AB.

D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



4211283-3/E 08/12

- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Publication IPC-7351 is recommended for alternate designs.
  - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

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